USB interface

Voltage regulator (LDO)

DC-DC for low loss 3.3V LED voltage supply

AUDIO section

GRID pads for heat sinks

Anker/Red (624nm) LED

Deep Blue (452nm) LED

Iron Green (510nm) LED

Bright White LED

Lens/diffuser

Title: DevPack LED&AUDIO

Drawn: Checked: Size: Rev: Sheet: of

Date: Friday, July 04, 2014
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